

SID

Factory: Rot am See

Article:

ML8

Provided:

Customer:

Date:

03.04.2026

WÜRTH  
ELEKTRONIK  
MORE THAN  
YOU EXPECT

Processtechnology: B: undefined

Material Text	Mat. Nr.	µm	Stackup	Process overview
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A-RS Kupferfolie-018my 330x490mm	50200238	18	VS	1		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	122		2		
C-RAS-FR4-PP-106-H71-TG150-HF-EM-37B(...	50202996	0		3		
		18	L2			
A-RS-FR4-ML-0.152mm-018+018-TG150-HF-...	50203026	152		4	A01	
		18	L3			
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	139		5		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		6		
		18	L4			
A-RS-FR4-ML-0.152mm-018+018-TG150-HF-...	50203026	152		7	A02	B00
		18	L5			
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	139		8		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		9		
		18	L6			
A-RS-FR4-ML-0.152mm-018+018-TG150-HF-...	50203026	152		10	A03	
		18	L7			
C-RAS-FR4-PP-106-H71-TG150-HF-EM-37B(...	50202996	122		11		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		12		
A-RS Kupferfolie-018my 330x490mm	50200238	18	RS	13		

Thickness after Pressing

B00:

1090 µm

Tol+:

120 µm

Tol-:

120 µm

Dmax:

1210 µm

Dmin:

970 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

1200 µm

Tol+:

120 µm

Tol-:

120 µm

Dmax:

1320 µm

Dmin:

1080 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal:

1122 µm

Version 1.2.20.35

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